Trends and Prospects in Multimedia

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Message from the Collection Editors

This topical collection aims to introduce the latest research on multimedia signals, including digital contents and the various devices supporting them, in the open access journal *Applied Sciences*. We are currently open for manuscripts from authors interested in this topical collection. We look forward to the submission of creative research papers and review papers on related topics in this field of research that will enhance the quality of this collection and advance the knowledge base of this subject.

In this Special Issue we welcome both original research papers and review articles on diverse topics such as:

- multimedia systems
- multimedia processing
- multimedia applications
- multimedia security
- system software for multimedia
- system hardware for multimedia
- network for multimedia
- signal processing for multimedia
- AI technology for multimedia
- every topic related multimedia

TopicalCollection

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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